

SGH15N120RUFD

Short Circuit Rated IGBT

General Description

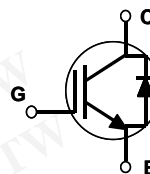
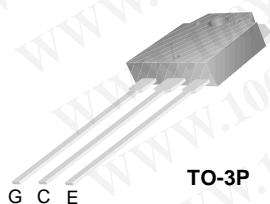
Fairchild's Insulated Gate Bipolar Transistor(IGBT) RUFD series provides low conduction and switching losses as well as short circuit ruggedness. RUFD series is designed for the applications such as motor control, UPS and general inverters where short-circuit ruggedness is required.

Features

- Short Circuit Rated 10 μ s @ T_C = 100°C, V_{GE} = 15V
- High Speed Switching
- Low Saturation Voltage : V_{CE(sat)} = 2.3 V @ I_C = 15A
- High Input Impedance
- CO-PAK, IGBT with FRD : t_{rr} = 70ns (typ.)

Application

AC & DC Motor Controls, General Purpose Inverters, Robotics, Servo Controls



Absolute Maximum Ratings

T_C = 25°C unless otherwise noted

Symbol	Description	SGH15N120RUFD	Units
V _{CES}	Collector-Emitter Voltage	1200	V
V _{GES}	Gate-Emitter Voltage	± 25	V
I _C	Collector Current @ T _C = 25°C	24	A
	Collector Current @ T _C = 100°C	15	A
I _{CM(1)}	Pulsed Collector Current	45	A
I _F	Diode Continuous Forward Current @ T _C = 100°C	15	A
I _{FM}	Diode Maximum Forward Current	90	A
T _{SC}	Short Circuit Withstand Time @ T _C = 100°C	10	μs
P _D	Maximum Power Dissipation @ T _C = 25°C	180	W
	Maximum Power Dissipation @ T _C = 100°C	72	W
T _J	Operating Junction Temperature	-55 to +150	°C
T _{stg}	Storage Temperature Range	-55 to +150	°C
T _L	Maximum Lead Temp. for soldering PurPoses, 1/8" from case for 5 seconds	300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
R _{θJC} (IGBT)	Thermal Resistance, Junction-to-Case	--	0.69	°C/W
R _{θJC} (DIODE)	Thermal Resistance, Junction-to-Case	--	1.0	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	--	40	°C/W

Electrical Characteristics of IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
$V_{V_{CES}}$	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	1200	--	--	V
$\frac{\Delta B_{V_{CES}}}{\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	--	0.6	--	V/°C
I_{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	--	--	1	mA
I_{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	--	--	± 100	nA

On Characteristics

$V_{GE(th)}$	G-E Threshold Voltage	$I_C = 15mA, V_{CE} = V_{GE}$	3.5	5.5	7.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C = 15A, V_{GE} = 15V$	--	2.3	2.7	V
		$I_C = 24A, V_{GE} = 15V$	--	2.8	--	V

Dynamic Characteristics

C_{ies}	Input Capacitance	$V_{CE} = 30V, V_{GE} = 0V, f = 1MHz$	--	1400	--	pF
C_{oes}	Output Capacitance		--	135	--	pF
C_{res}	Reverse Transfer Capacitance		--	45	--	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600V, I_C = 15A, R_G = 20\Omega, V_{GE} = 15V, \text{Inductive Load, } T_C = 25^\circ C$	--	20	--	ns
t_r	Rise Time		--	60	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	60	110	ns
t_f	Fall Time		--	150	200	ns
E_{on}	Turn-On Switching Loss		--	1.0	--	mJ
E_{off}	Turn-Off Switching Loss	--	0.98	--	mJ	
E_{ts}	Total Switching Loss	--	1.98	2.8	mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600V, I_C = 15A, R_G = 20\Omega, V_{GE} = 15V, \text{Inductive Load, } T_C = 125^\circ C$	--	20	--	ns
t_r	Rise Time		--	70	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	80	150	ns
t_f	Fall Time		--	200	270	ns
E_{on}	Turn-On Switching Loss		--	1.13	--	mJ
E_{off}	Turn-Off Switching Loss	--	1.50	--	mJ	
E_{ts}	Total Switching Loss	--	2.63	3.81	mJ	
T_{sc}	Short Circuit Withstand Time	$V_{CC} = 600V, V_{GE} = 15V @ T_C = 100^\circ C$	10	--	--	μs
Q_g	Total Gate Charge	$V_{CE} = 600V, I_C = 15A, V_{GE} = 15V$	--	72	108	nC
Q_{ge}	Gate-Emitter Charge		--	10	15	nC
Q_{gc}	Gate-Collector Charge		--	30	45	nC
L_e	Internal Emitter Inductance	Measured 5mm from PKG	--	14	--	nH

Electrical Characteristics of DIODE T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{FM}	Diode Forward Voltage	$I_F = 15A, T_C = 25^\circ C$	--	2.9	3.5	V
		$T_C = 100^\circ C$	--	2.7	--	
t_{rr}	Diode Reverse Recovery Time	$T_C = 25^\circ C$	--	70	100	ns
		$T_C = 100^\circ C$	--	85	--	
I_{rr}	Diode Peak Reverse Recovery Current	$I_F = 15A, dl/dt = 200A/\mu s, T_C = 25^\circ C$	--	7.0	9.0	A
		$T_C = 100^\circ C$	--	8.5	--	
Q_{rr}	Diode Reverse Recovery Charge	$T_C = 25^\circ C$	--	245	450	nC
		$T_C = 100^\circ C$	--	360	--	

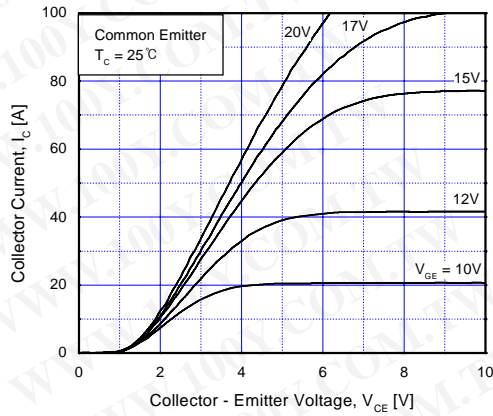


Fig 1. Typical Output Characteristics

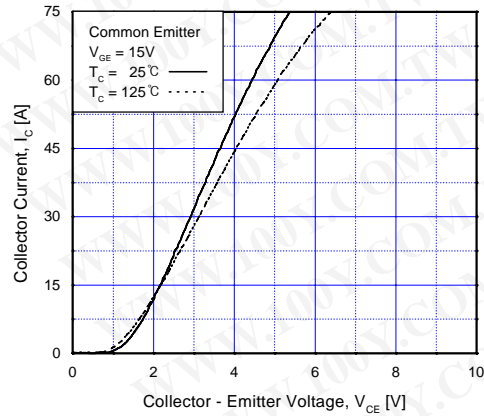


Fig 2. Typical Saturation Voltage Characteristics

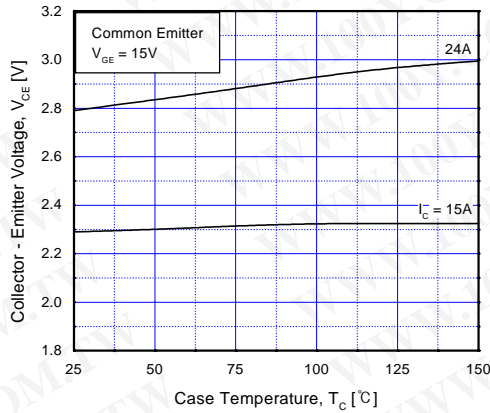


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

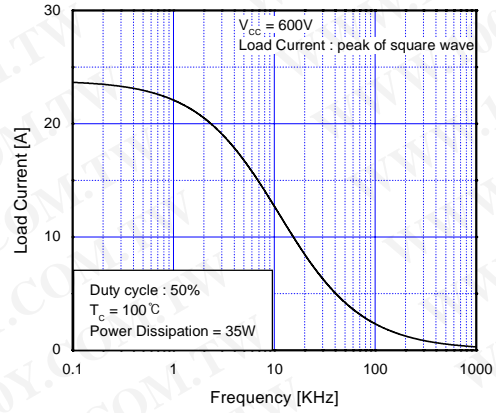


Fig 4. Load Current vs. Frequency

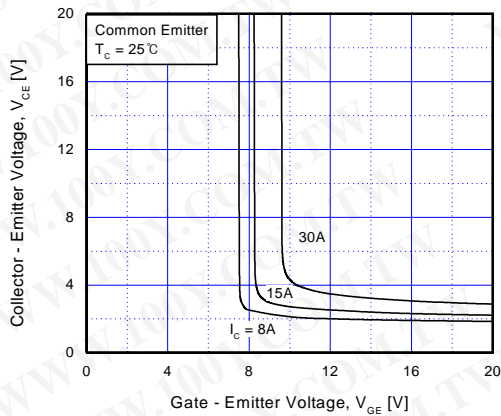


Fig 5. Saturation Voltage vs. V_{GE}

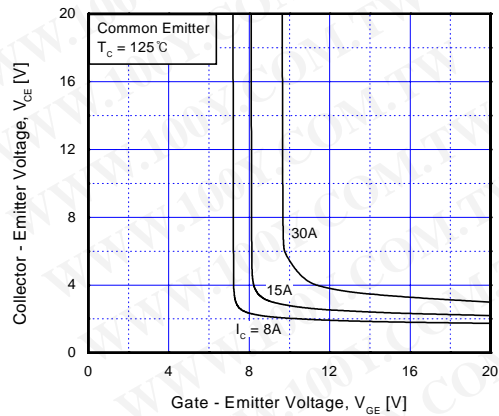


Fig 6. Saturation Voltage vs. V_{GE}

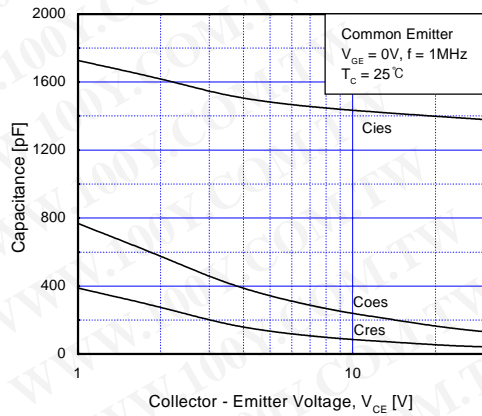


Fig 7. Capacitance Characteristics

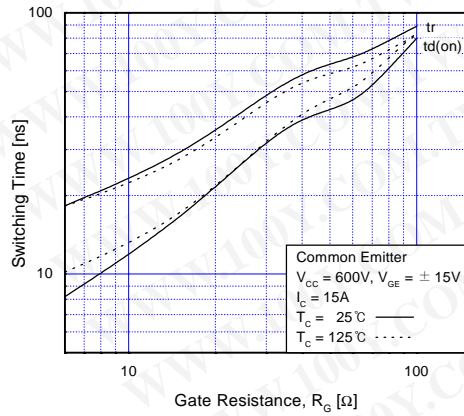


Fig 8. Turn-On Characteristics vs. Gate Resistance

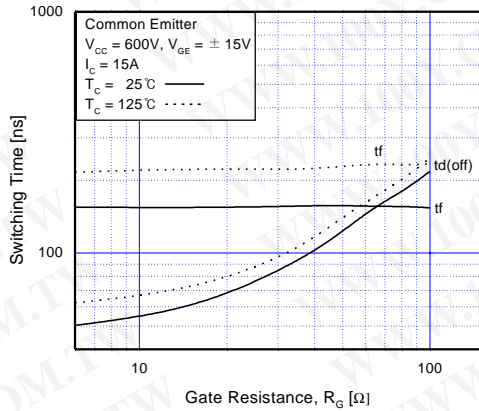


Fig 9. Turn-Off Characteristics vs. Gate Resistance

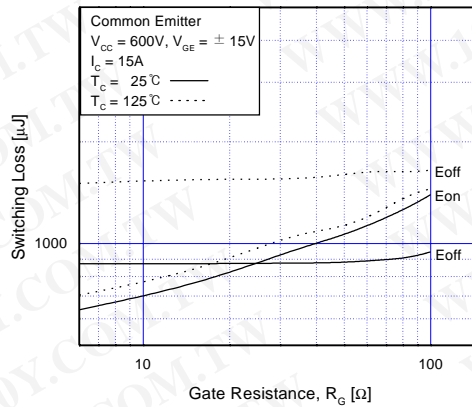


Fig 10. Switching Loss vs. Gate Resistance

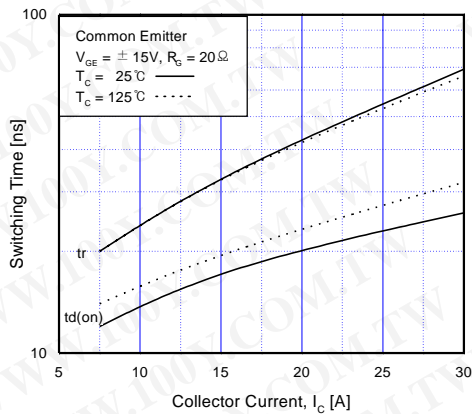


Fig 11. Turn-On Characteristics vs. Collector Current

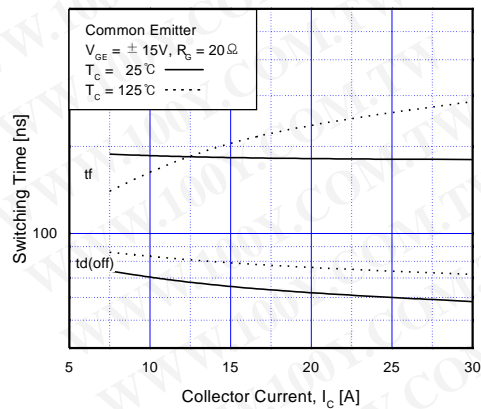


Fig 12. Turn-Off Characteristics vs. Collector Current

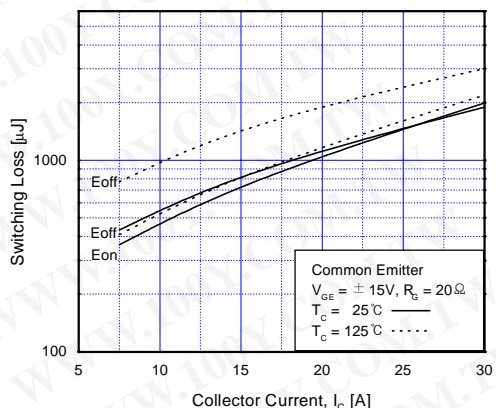


Fig 13. Switching Loss vs. Collector Current

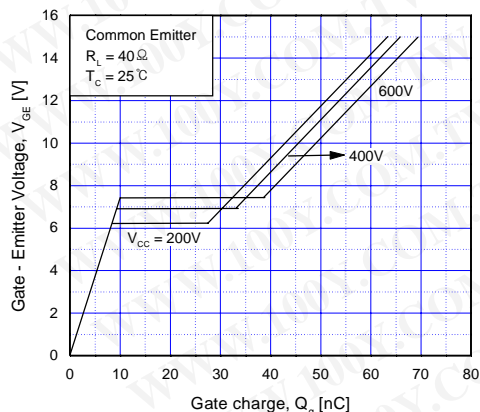


Fig 14. Gate Charge Characteristics

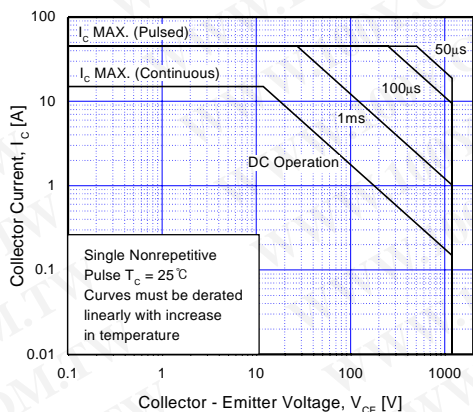


Fig 15. SOA Characteristics

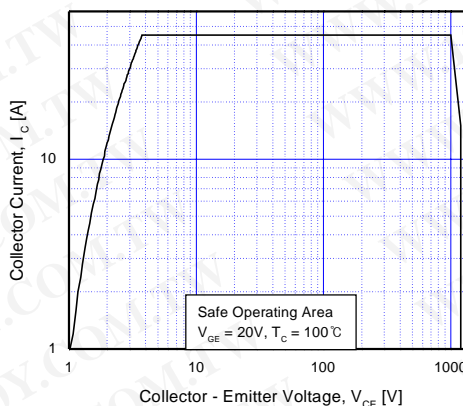


Fig 16. Turn-Off SOA

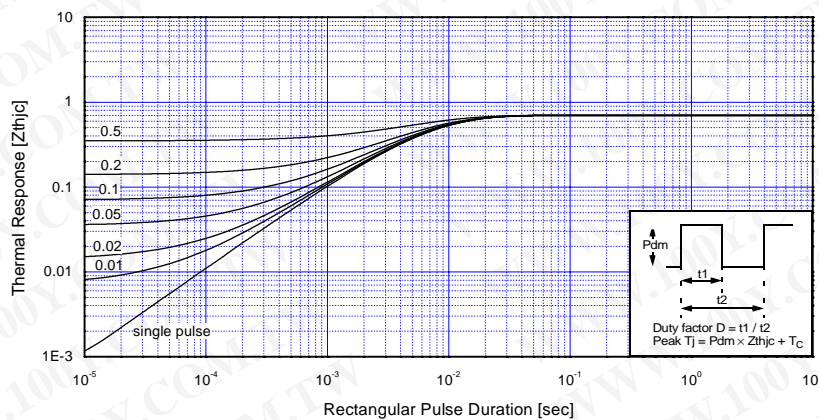


Fig 17. Transient Thermal Impedance of IGBT

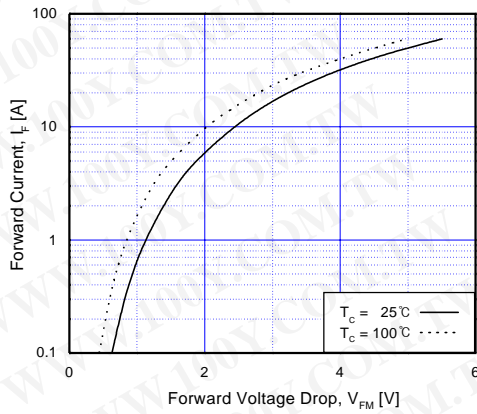


Fig 18. Forward Characteristics

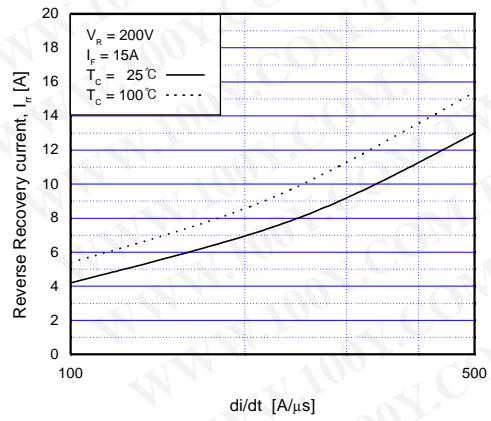


Fig 19. Reverse Recovery Current

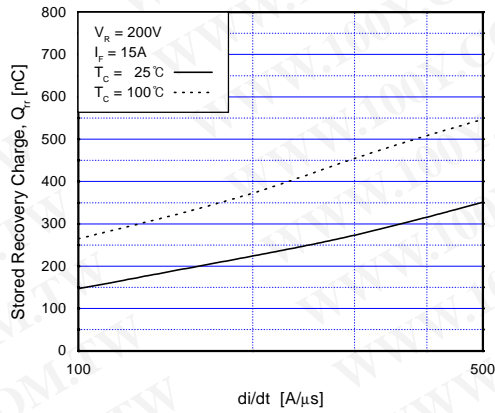


Fig 20. Stored Charge

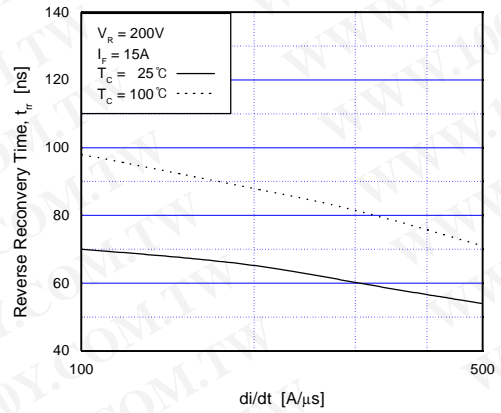


Fig 21. Reverse Recovery Time

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